

POE-D04-00-E-11

50V,100V,500V,1KV,2KV Hi-K CERAMIC DISC CAPACITOR FOR DOWN SIZE PRODUCT

Ver: 11

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# PRODUCT SPECIFICATION

PRODUCT: CERAMIC DISC CAPACITOR

50V, 100V, 500V, 1KV, 2KV HI-K TYPE: CERAMIC

**CAPACITOR DOWN SIZE PRODUCT** 

CUSTOMER:_		
DOC. NO.:	POE-D04-00-E-11	
Ver.:	11	

### APPROVED BY CUSTOMER

60
VAAICM
POFIcetronic POE

### **Record of change**

Date	Version	Description	page
2008.6.3	1	1. D15-00-E-09 (before) → POE-D04-00-E-01 (1 <sup>st</sup> edition)	
2008.8.22	2	Revised diameter	5-7
		2. Complete lead code	16-19
		3. Add last SAP code "H" for halogen and Pb free, epoxy resin	8
2008.12.12	3	1.Complete lead code of SAP P/N	3-7
		2. Page layout adjustment.	
		3. Added marking when the coating resin is Halogen and Pb free Epoxy.	
2009.8.5	4	1. Change PSA & POE logo to Walsin & POE logo.	
2011/8/24	5	1. Delete the definition about "Old Part No."	5-6
		2. Review the diameter dimension code of "Z5U 1KV 332/362" from 060 to be 070.	7
		3. Delete the Part No. of "Z5U 50V/100V 223".	
			7
2011/11/25	6	1. Review the item Y5P/Z5U/Z5V	7-8
		2. Add the Y5U temperature characteristic	4-15
2012/11/06	7	1. Revise the temp.(TCC): Y5P(-25 $^{\circ}$ C to 85 $^{\circ}$ C/ to 125 $^{\circ}$ C) & Cap. Change( $\pm 10\%$ / $\pm 35\%$ )	4
		2. Review the OP temp. for Y5P: Y5P: $-25^{\circ}$ $\sim +105^{\circ}$ (INCLUDING CAPACITOR'S	12-13
		SELF-HEATING MAX.+20°C)	
2013/5/6	8	1. Review the Lead diameter φ from 0.60 +/-0.06mm to 0.55+/-0.05mm	6,9
		2. Review the "D $\Phi \le 6.0$ mm shall be omitted." to "D $\Phi \le 0.0$ 0 shall be omitted."	8
		3. Review the Solderability temperature from 255(+5/-0)°C to 245±5°C., Solderability	
		time from 2 $\pm 0.5$ s to $5\pm 0.5$ s,	12
2013/10/18	9	Review the packing specification	10
2015/8/4	10	1. Review the temperature range:Y5P(-25°C to+105°C)Change (-25°C to+125°C)	11
		2. review the high temperature loading:FOR 1000(+48/-0) HOURS AT $85 \pm 2^{\circ}$ C	13
		(FOR Y5U, Z5U, Z5V) / AT $105 \pm 3^{\circ}$ (ONLY FOR Y5P) AND THEN DRIED FOR	
		$12\sim24$ HOURS AND MEASURED.Change FOR $1000(+48/-0)$ HOURS AT $85\pm2^{\circ}$ C	
		(FOR Y5U, Z5U, Z5V) / AT 125 $\pm$ 3°C (ONLY FOR Y5P) AND THEN DRIED FOR	
		$12\sim24$ HOURS AND MEASURED.	
2015/11/5	11	Review the Available lead code of Lead Configuration.	5-6
		2. Modify the contents of the use of epoxy resin for 1KV products	7-8
		3. Review the Specification and test method	12-13
		4. Review 8. Cautions & notices	14
		5. Review 9. Drawing of internal structure and material list	16
		J. Keview 3. Drawing of internal structure and material fist	

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1. Part number for SAP system(total eighteen code ):

• Temperature characteristic:

Code	YU(Y5U)	YP(Y5P)	ZU(Z5U)	ZV(Z5V)
Operating temperature	-25°C to +85°C	$-25^{\circ}\text{C to } +85^{\circ}\text{C} / 85^{\circ}\text{C to } +125^{\circ}\text{C}$ $+10^{\circ}\text{C to } +85^{\circ}\text{C}$		o +85°C
Cap. change	-56%~+22%	±10% / ±35%	-56%~+22%	-82%~+22%

2 Rated voltage (Vdc):

I	Voltage	50V	100V	500V	1000V	2000V
	Code	500	101	501	102	202

**3**Capacitance(pF):

Capacitors (pF)	100	470	1000	2200	4700
Code	101	471	102	222	472

**O**Capacitance tolerance :  $K=\pm 10\%$   $M=\pm 20\%$  Z=+80% -20%

**6** Nominal body diameter dimension (Ref.to page.7~8 Dφ Code spec.) .

**6** Code of lead type: Please refer to Item "2.Mechanical".

• Packing mode and lead's length (identified by 2-figure code)

Taping Code	Description	
AN	Ammo / Pitch of component:12.7 mm	

<b>Bulk Code</b>	Description
3E	Lead's length L: 3.5mm
04	Lead's length L: 4.0mm
4E	Lead's length L: 4.5mm
20	Lead's length L: 20mm

8 Length tolerance

Code	Description		
A	$\pm 0.5$ mm(Only for short kink lead code "D / X / H")		
В	±1.0 mm		
С	Min.		
D	Taping special purpose		

#### **9**Pitch

Code	Description	C	Code	Description
5	5.0±0.8mm (For Bulk)		7	7.5 ±1mm
5	5.0+0.8mm-0.2mm (For Taping)		0	$10.0 \pm 1$ mm
2	2.5 ±0.8 mm			

Coating code

Code	Description	
P	Phenolic resin -Pb free	
A	Halogen free and Pb free, phenolic resin	
В	Epoxy Resin, Pb free	
Н	Halogen free and Pb free, epoxy resin	

### 2. Mechanical:

Available lead code: (unit: mm)

	SAP P/N	Pitch	Lead length	Available rated			
Lead type	(13-17) digits	(F)	(L)	voltage	<b>Packing</b>	Lead config	uration
	B20C2	$2.5 \pm 0.8$	20 MIN.	50V			
	B20C5	5.0 ± 0.8	20 MIN.			Dmax.	Tmax.
	B20C6	6.4 ± 1.0	20 MIN.		Bulk		
Lead style: B	B20C7	7.5 ± 1.0	20 MIN.	50V,500V, 1KV,2KV		\ \/e	l e
Straight long	B20C0	10 ± 1.0	20 MIN.	, , ,			\ <u> </u>
lead	BAND5	5.0 +0.8 -0.2					
	BAND2	$2.5 \pm 0.8$	Taping Spec. (Ref.to page.9)	50V	Tap. Ammo	Ød L	
	L05B2	$2.5 \pm 0.8$	5.0 ± 1.0	30 1		Dmay	Tark
	L4EB5	$5.0 \pm 0.8$	4.5 ± 1.0			Dmax.	Tmax.
	L05B5	$5.0 \pm 0.8$	5.0 ± 1.0				
Lead style: L	L05B6	6.4 ± 1.0	5.0 ± 1.0		- 4	( ) <sub>e</sub>	
Straight short	L4EB7	7.5 ± 1.0	4.5 ± 1.0	50V,500V, 1KV, 2KV	Bulk		
lead	L05B7	7.5 ± 1.0	5.0 ± 1.0			Øa	ΠΠ *
	L4EB0	10 ± 1.0	4.5 ± 1.0			<del>▗▘</del> ▋╸ ┌	
	L05B0	10 ± 1.0	5.0 ± 1.0			- <del></del> -	
	H3EA5	$5.0 \pm 0.8$	$3.5 \pm 0.5$				
	H04A5	$5.0 \pm 0.8$	$4.0 \pm 0.5$				
	H4EB5	$5.0 \pm 0.8$	4.5 ± 1.0				
	H05B5	$5.0 \pm 0.8$	5.0 ±1.0				
	H20C5	$5.0 \pm 0.8$	20 MIN.			_	
	H3EA7	$7.5 \pm 1.0$	$3.5 \pm 0.5$			Dmax.	Tmax.
	H04A7	$7.5 \pm 1.0$	$4.0 \pm 0.5$			×	
Lead style: H	H4EB7	$7.5 \pm 1.0$	4.5 ± 1.0	50V,500V, 1KV, 2KV	Bulk	( ) [2]	
Inside kink	H05B7	$7.5 \pm 1.0$	5.0 ±1.0			5.0max	5.0max
lead	H20C7	$7.5 \pm 1.0$	20MIN			K X	HH
	H3EA0	10 ± 1.0	$3.5 \pm 0.5$			Ød→∏→ ∏	
	H04A0	10 ± 1.0	$4.0 \pm 0.5$			U F U <u>- 1</u>	<u> П П                               </u>
	H4EB0	10 ± 1.0	4.5 ± 1.0				
	H05B0	10 ± 1.0	5.0 ±1.0				
	H20C0	10 ± 1.0	20 MIN.				
	HAND5	5.0 +0.8 -0.2	Taping SPEC. (Ref.to page.9)	50V,500V, 1KV, 2KV	Tap. Ammo		
	X3EA5	5.0±0.8					
	X3EA7	7.5±1.0	$3.5 \pm 0.5$			Dmax.	Tmax.
	X3EA0	10±1.0					
Lead style: X	X04A5	5.0±0.8				5.0max	5.0max
Outside kink	X04A7	7.5±1.0	$4.0 \pm 0.5$	50V,500V, 1KV, 2KV	Bulk	(2)	
lead	X04A0	10±1.0				$\lambda - k$	YY
	X05B5	5.0±0.8				Ød T	
	X05B7	7.5±1.0	$5.0 \pm 1.0$			<u> Греги Сф</u>	<u> </u>
	X05B0	10±1.0	5.0 = 1.0			1-3	
	D04A5	5.0±1.0	40 10 7			Dmax.	Tmay
Lead style: D	D04A7	7.5±1.0	$4.0 \pm 0.5$			Dillax.	Tmax.
	D04A0	10±1.0			Bulk	× ×	
Vartical 1-:1	D3EA5	5.0±0.8		50V,500V, 1KV, 2KV	Duik	( <u>)</u>	4max
Vertical kink short lead	D3EA7	7.5±1.0	$3.5 \pm 0.5$	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			(,4) ~ !
Short lead	D3EA0	10±1.0	1			øa ∥ ∥_	¥.
			Taping SPEC.		Т А	<del>   -</del>     <u>-  </u>	<u> </u>
	DAND5	5.0 <sup>+0.8</sup> -0.2	(Ref.to page.9)		Tap. Ammo	<del>  </del>	



Lead type	SAP P/N (13-17) digits	Pitch (F)	Lead length (L)	Available rated voltage	Packing	Lead configuration
	M05B5	$5.0 \pm 0.8$				Dmax. Tmax.
	M05B7	$7.5 \pm 1.0$	$5.0 \pm 1.0$			
Lead style: M	M05B0	10 ± 1.0				Omax Omax
Double	M04B5	$5.0 \pm 0.8$		50V,500V, 1KV, 2KV	Bulk	
outside kink	M04B7	7.5 ± 1.0		30 v,300 v, 1K v, 2K v	Bulk	
lead	M04B0	10 ± 1.0	4.0 ± 1.0			Ød L

- % Lead diameter  $\phi$ = 0.55 +/-0.05 mm
- \*\* Phenolic resin coating for 50V/500V product; Phenolic resin or Epoxy resin coating for 1KV product; Epoxy resin coating for 2KV product.
- **※ e** (Coating **extension** on leads):

For straight lead style: 1.5mmMax when the rated voltage is 50Vdc & 100Vdc;

2.0mmMax when the rated voltage is 500Vdc and 1KVdc;

3.0mmMax when the rated voltage is 2KVdc.

For kink lead style: not exceed the kink.

%When Dφ≥11mm, only for bulk, but Dφ≤10mm can do Bulk or Taping.



### 3. Capacitance value vs. rated voltage, product diameter:

T.C.						Y5	P(C	LASS	П,Т	<b>Tempe</b>	ratur	e:-25	℃~+8	85℃,′	Г.С.С	::±10	% &	+85℃	~+12	25℃,′	Г.С.С	:::±35	<b>%</b> )					
Rate voltage			50	V, 100	OV							500V							1 F	ζV					2 <b>k</b>	ΚV		
Dφ (Code)	040	050	060	070	080	090	100	040	050	060	070	080	090	100	110	130	050	060	070	080	100	120	060	080	090	100	130	140
D max. (mm)	4.5	5.5	6.5	7.5	8.5	9.5	11.0	4.5	5.5	6.5	7.5	9.0	10.0	11.0	12.0	14.0	6.0	7.0	8.0	9.0	11.0	13.0	7.5	9.5	10.5	11.5	14.5	15.5
T max. (mm)	3.5	3.5	3.5	3.5	3.5	3.5	3.5	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5
100	101							101									101						101					
120	121							121									121						121					
150	151							151									151						151					
180	181							181									181						181					
200	201							201									201						201					
220	221							221									221						221					
240	241							241									241						241					
270	271							271									271						271					
330	331							331									331						331					
390	391							391									391						391					
470	471							471									471						471					
560	561							561									561						561					
680	681							681										681					681					
820	821								821									821						821				
1000	102								102									102						102				
1200		122								122									122						122			
1500		152								152									152						152			
1800		182									182									182					182			
2000		202									202									202					202			
2200		222									222									222					222			
2700			272									272									272					272		
3000			302									302									302							
3300			332										332								332						332	
3900				392									392									392					392	
4700				472										472								472						472
5000					502									502														
5600					562									562														
6800						682									682													
8200							822									822												
10000							103									103												
Packing		Tani	ng or l	Bulk		BU				Tani	ng or	Bulk			Bu			Tani	ng or	Bulk		Bulk	Bulk Taping or Bulk Bulk					
Coating								henoli	c Resi		8						Ph			or Ep	oxv Re					Resin		-

T.C.							Z5U	(CLA	SS Ⅱ,	Temp	eratur	e: +10	°C ~+8	5℃, T.	C.C.: -	+22~-5	56%)					
Rate voltage			50V,	100V				,	500V	•				1KV					2 K	(V		
Dφ(Code)	040	050	060	070	080	100	040	050	060	070	090	050	060	070	090	100	060	070	080	090	110	130
D max. (mm)	4.5	5.5	6.5	7.5	8.5	10.5	4.5	5.5	6.5	7.5	9.5	6.0	7.0	8.0	10.0	11.0	7.5	8.5	9.5	10.5	12.5	14.5
T max. (mm)	3.5	3.5	3.5	3.5	3.5	3.5	4.0	4.0	4.0	4.0	4.0	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5
1000								102				102					102					
1200								122				122					122					
1500								152				152						152				
1800								182				182										
2000	202							202				202										
2200	222							222				222						222				
2700	272							272						272					272			
3000	302													302								
3300	332								332					332					332			
3600	362								362					362						362		
3900	392								392					392						392		
4700	472									472				472						472		
5000		502												502								
5600										562											562	
6800										682					682						682	
8200			822													822						822
10000				103							103					103						103
Packing		-			-		-	-	-	Tapi	ng or B	ulk		-	-						Bu	ılk
Coating					Phe	nolic R	esin					Phen	olic Re	sin or E	poxy R	lesin			Epoxy	Resin		

T.C.						Y	5U (C	LASS	∏, Ten	nperatu	ıre: -25	5°C ~+8	5℃, T	.C.C.:	+22~-56	5%)					
Rate voltage		50	V,100	V				500V					1KV					2H	ΚV		
Dφ(Code)	050	060	070	080	100	060	070	080	090	100	050	060	070	090	110	060	070	080	090	110	140
D max. (mm)	5.5	6.5	7.5	8.5	10.5	6.5	7.5	8.5	9.5	10.5	6.0	7.0	8.0	10.0	12.0	7.5	8.5	9.5	10.5	12.5	15.5
T max. (mm)	3.5	3.5	3.5	3.5	3.5	4.0	4.0	4.0	4.0	4.0	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5
1000						102					102					102					
1200											122					122					
1500											152						152				
2000	202																				
2200	222					222						222						222			
2700	272						272						272					272			
3000	302																				
3300	332						332						332						332		
3600	362																				
3900	392						392						392						392		
4700	472							472						472					472		
5000	502																				
5600																				562	1
6800									682					682							
8200			822																		
10000			103							103					103						103
Packing							Taping	or Bull	ζ.	1					Bulk		Taping	or Bulk		Bı	ulk
Coating		Phenolic Resin									Phenolic Resin or Epoxy Resin Epoxy Resin										

T.C.			Z5V (CLAS	SS <b>I</b> , Tempera	ture: +10°C ~-	+85℃, T.C.C.:	+22~-82%)		
Rate voltage		50V,	100V		500V		1KV		2KV
Dφ(Code)	050	060	070	080	080	060	080	100	120
D max. (mm)	5.5	6.5	7.5	8.5	9.0	7.0	9.0	11.0	13.5
T max. (mm)	3.5	3.5	3.5	3.5	4.0	4.5	4.5	4.5	4.5
1000	102								
1200	122								
1500	152					152			
1800	182					182			
2000	202					202			
2200	222					222			
2700	272					272			
3000	302					302			
3300	332								
3600	362								
3900	392						392		
4700	472						472		
5000							502		
10000		103			103			103	103
20000			203						
22000				223					
Packing		1		Taping o	r Bulk	1			Bulk
Coating		Phenolic Resin Phenolic Resin or Epoxy Resin							

## 4. Marking:

Marking Remarks		(2) 102K (4) (5) (6)			
(1). Temp. char.	Y5P: Be marke	ed "B"; Z5U(Y5U): Be marked "E"; Z5V: Shall be omitted			
(2). Rated capacitance	Identified by 3-1	Figure Code. Ex. 1000pF→"102",4700pF→"472"			
	50V&100V	Marked with code "_" under the rated capacitance.			
(3). Rated voltage	500V	No any marking under the rated capacitance.			
	1000V&2000V	Marked with code: 1000V→"1KV", 2000V→"2KV"			
(4). Capacitance tolerance	K=±10%(for Y5	$SP) \cdot M = \pm 20\% (for Z5U\&Y5U) \cdot Z = +80\% - 20\% (for Z5V)$			
(5). Manufacturer's identification	Shall be marked	as "♥", but DΦ≤060 shall be omitted.			
(6). Halogen and Pb free	There is a "_"marking under the code "V" when the coating resin is Haloge and Pb free Epoxy.				

50V,100V,500V,1KV,2KV Hi-K CERAMIC DISC CAPACITOR FOR DOWN SIZE PRODUCT

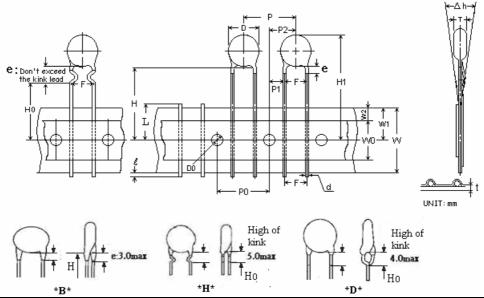
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### 5. Taping specifications:

\* Lead spacing:  $F=5.0^{+0.8}_{-0.2}$  (mm)

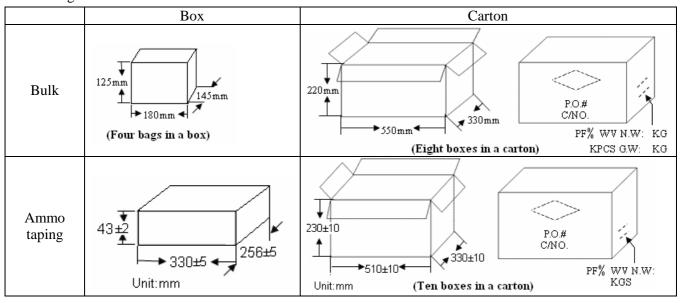
• 12.7mm pitch/lead spacing 5.0mm taping Lead code: \*BAND5 & \*DAND5 & \*HAND5



Item		Symbol	Spec	cification	Remarks
Item		Symbol	Value	Tolerance	Kemarks
Body diameter		D	*	max.	See Section "3. Capacitance value vs. rated
Body thickness		T	*	max.	voltage, product diameter".
Lead-wire diameter		d	0.55	±0.05	
Pitch of component		P	12.7	±1.0	
Feed hole pitch	P0	12.7	±0.3	Cumulative pitch erroe:1.0mm/20 pitch	
Feed hole center to lead		P1	3.85	±0.7	To be measured at bottom of clinch
Hole center to component center		P2	6.35	±1.3	
Lead-to-lead distance		F	5.0	+0.8,-0.2	
Component alignment, F-R		∆h	0	±2.0	
Tape width		W	18.0	+1.0,-0.5	
Hole-down tape width		W0	11.0	min.	
Hole position		W1	9.0	+0.75,-0.5	
Hole-down tape position		W2	3.0	max.	
Height of component form tape	For straight lead type	Н	20.0	+1.0 -0.5	
center	For kinked lead type	H0	16.0	±0.5	
Component height		H1	32.25	max.	
Lead-wire protrusion	Q	2.0	max.	Or the end of lead wire may be inside the tape.	
Food hole diameter		DÔ	4.0	±0.2	
Total tape thickness		t	0.7	±0.2	Ground paper:0.5±0.1mm
Length of sniped lead		L	11.0	max.	
Coating rundown on leads	e	]	Please refer to	page 6 "e(Coating extension on leads)".	

### 6. Packing Baggage:

### 6.1 Packing size:



### 6.2 Packing quantity:

Packing type	Th	ne code of 14th to15th in SAP P/N	MPQ (Kpcs/l	Box)	Remark			
Toning		AN	2		Phenolic resin			
Taping		AN	1.5		Epoxy resin			
Packing type	Lead length	Size code of 10th to 12th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box	Remark			
		040~070	1	3	Phenolic resin			
	v 1 1	080~100	1	2	Phenolic resin			
	Long lead (L≧ 16mm)	050~100	1	2	Epoxy resin			
D11-	Tommi	110~120	0.5	1.5				
Bulk		130~140	0.5	1				
		040~060	1	6				
	Short lead	070~080	1	4				
	16mm)	(L< 16mm)	•	000 100		1	3	
	ĺ	110~140	1	2				

#### 7. Specification and test method:

7.1 SCOPE: THIS SPECIFICATION APPLIES TO HI-K CERAMIC TYPE CAPACITOR.

#### 7.2 TEST CONDITIONS:

UNLESS OTHERWISE SPECIFIED, ALL TESTS SHALL BE OPERATED AT THE STANDARD TEST CONDITIONS OF TEMPERATURE 5°C TO 35°C AND RELATIVE HUMIDITY 45% TO 85%. WHEN FAILS A TEST, RETEST BE OPERATED AT THE CONDITIONS OF TEMPERATURE 25°C  $\pm$  2°C, RELATIVE HUMIDITY OF 60% TO 70% AND BAROMETRIC PRESSURE 860 TO 1060 MBAR.

7.3 HANDLE PROCEDURE: TO AVOID UNEXPECTED TESTING RESULTS FROM OCCURRING, THE TESTED CAPACITOR MUST BE KEPT AT ROOM TEMPERATURE FOR AT LEAST 30 MINUTES AND COMPLETELY DISCHARGED.

#### 7.4 TEST ITEMS:

ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE
APPEARANCE STRUCTURE SIZE	NO ABNORMALITIES	AS STATED IN SECTION 3.
MARKING		AS STATED IN SECTION 4
	BETWEEN TERMINALS: NO ABNORMALITIES	A. BELOW 1KV: 250% RATED VOLTAGE WITH 50mA MAX. CHARGING CURRENT FOR 1~5 SEC.  B. 1KV & ABOVE: 200% RATED VOLTAGE WITH 50mA MAX. CHARGING CURRENT FOR 1~5 SEC.
WITHSTAND VOLTAGE	BETWEEN TERMINAL AND	SMALL METALLIC BALLS WITH 1mm DIAMETERS SHALL BE PUT ON A VESSEL AND THE TEST CAPACITOR SHALL BE SUBMERGED EXCEPT 2mm FROM THE TOP OF ITS COMPONENT BODY.
	ENCLOSURE : NO ABNORMALITIES	THE TEST VOLTAGE SHALL BE APPLIED BETWEEN THE SHORT-CIRCUITED TERMINALS AND THE METALLIC BALLS.
		(APPLY 1.3KV DC VOLTAGE BETWEEN TERMINALS AND ENCLOSURE FOR $1\sim5$ SEC)
INSULATION RESISTANCE	10000 MΩ MIN	INSULATION RESISTANCE SHALL BE MEASURED AT 60±5 SECONDS AFTER RATED VOLTAGE APPLIED.  RATED VOLTAGE :100V =100V  500V & ABOVE = 500V
CAPACITANCE	TOLERANCE: K:±10% M:±20% Z:+80-20%	TESTING FREQUENCY: 1 KHZ $\pm$ 20% TESTING TEMPERATURE: 25 $\pm$ 2°C TESTING VOLTAGE: 1.0 $\sim$ 5.0 Vrms
TEMPERATURE RANGE	Y5P: $-25^{\circ}$ C $\sim +125^{\circ}$ C (INCLUDII) Y5U: $-25^{\circ}$ C $\sim +85^{\circ}$ C Z5U & Z5V: $+10^{\circ}$ C $\sim +85^{\circ}$ C	NG CAPACITOR'S SELF-HEATING MAX.+20°C)
DISSIPATION FACTOR ( D.F )	Y5P : BELOW 2.5% Z5U & Y5U : BELOW 2.5% Z5V : BELOW 5.0%	AS ABOVE STIPULATION OF CAPACITANCE





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50V,100V,500V,1KV,2KV Hi-K CERAMIC DISC CAPACITOR FOR DOWN SIZE PRODUCT

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ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE
TEMPERATURE CHARACTERISTIC	CAP. CHANGE: Y5P: WITHIN ± 10%(-25°C to +85°C) & WITHIN ± 35%(85°C to +125°C) Z5U & Y5U: WITHIN -56,+22% Z5V: WITHIN -82,+22%	CAPACITANCE SHALL BE MEASURED AT $25^{\circ}$ C. AND CLASSIFIED AS CAP. CHANGE: CLASS Y5P: $-25^{\circ}$ C $\sim$ $+125^{\circ}$ C CLASS Y5U: $-25^{\circ}$ C $\sim$ $+85^{\circ}$ C CLASS Z5U&Z5V: $+10^{\circ}$ C $\sim$ $+85^{\circ}$ C Pre-treatment: Capacitor shall be stored at $125\pm3^{\circ}$ C for 1 hour. then placed at $125\pm3^{\circ}$ C for 1 hour. then placed at $125\pm3^{\circ}$ C for 2 hour.
TERMINAL STRENGTH	TENSILE STRENGTH : NO BREAKDOWN	WIRE DIA.0.5 M/M, LOADING WEIGHT 0.5KG FOR 10±1 SECONDS WIRE DIA.0.6 M/M, LOADING WEIGHT 1.0KG FOR 10±1 SECONDS
STRENGTH	BENDING STRENGTH : NO BREAKDOWN	WIRE DIA.0.5 M/M, LOADING WEIGHT 0.25 KG WIRE DIA.0.6 M/M, LOADING WEIGHT 0.5 KG (BENDING BACK AND FORTH 90 DEGREE TWICE)
SOLDERABILITY	LEAD WIRE SHALL BE SOLDERED OVER 3/4 OF THE CIRCUMFERENTIAL DIRECTION.	TO COMPLY WITH JIS-C-5102 8.4 SOLDER TEMPERATURE 245±5°C AND DIPPING TIME 5±0.5 SECONDS. FLUX: WEIGHT RATIO OF POSIN 25%
	APPEARANCE : NO ABNORMALITIES	LEAD WIRE OR TERMINALS SHALL IMMERSE UP TO 2.0 M/M FORM BODY.  (A) BODY DIA < 5.0mm; INTO THE MOLTEN SOLDER OF
	CAP. CHANGE : Y5P : ±5% MAX Z5U & Y5U : ±15% MAX Z5V : ±20%	<ul> <li>(A) BODY DIA. ≤ 5.0mm: INTO THE MOLTEN SOLDER OF WHICH TEMPERATURE: 260(+5/-0)°C FOR 3.0±0.5 SECONDS.</li> <li>(B) BODY DIA. &gt; 5.0mm: INTO THE MOLTEN SOLDER OF WHICH TEMPERATURE 260(+5/-0)°C FOR 5~10 SECONDS.</li> </ul>
SOLDERING HEAT RESISTANCE	WITHSTAND VOLTAGE: (BETWEEN TERMINALS) NO ABNORMALITIES	THEN LEAVE AT STANDARD TEST CONDITIONS FOR 24±2 HOURS, THEN MEASURED.  **WHEN SOLDERING CAPACITOR WITH A SOLDERING IRON, IT SHOULD BE PERFORMED IN FOLLOWING CONDITIONS.  TEMPERATURE OF IRON-TIP: 350~400 °C  SOLDERING IRON WATTAGE: 50W MAX.  SOLDERING TIME: 3.5 SEC. MAX.
HUMIDITY CHARACTERISTIC (STABLE SITUATION)	APPEARANCE: NO ABNORMALITIES  CAP. CHANGE: Y5P: ± 15% MAX Z5U & Y5U: ± 20% MAX Z5V: ± 30% MAX  D.F. Y5P: 5% MAX Z5U & Y5U: 5% MAX Z5U & Y5U: 5% MAX INSULATION RESISTANCE: 1000MΩ MIN.	CAPACITORS SHALL BE SUBJECTED TO A RELATIVE HUMIDITY OF 90 $\sim$ 95% AT 40±2°C FOR 500(+24/-0) HOURS. THEN DRIED FOR 1 $\sim$ 2 HOURS AND MEASURED.





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50V,100V,500V,1KV,2KV Hi-K CERAMIC DISC CAPACITOR FOR DOWN SIZE PRODUCT

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ITEM	POST-TEST REQUIREMENTS	TESTING PROCEDURE
	APPEARANCE:	CAPACITORS SHALL BE SUBJECTED TO A RELATIVE
	NO ABNORAMLITIES	HUMIDITY OF 90 $\sim$ 95% AT $40 \pm 2$ °C FOR 500(+24/-0)
	CAP. CHANGE :	HOURS WITH RATED VOLTAGE APPLIED WITH 50mA
	Y5P: ±15% MAX	MAX., THEN DRIED FOR $1\sim2$ HOURS AND MEASURED.
	Z5U & Y5U: ±20% MAX	Pre-treatment:
HUMIDITY	Z5V: ±30% MAX	Capacitor shall be stored at125±3°C for 1hour.then placed at¾
LOADING	D.F.	1room condition for 24±2hours
	Y5P: 5% MAX	
	Z5U & Y5U : 5% MAX	
	Z5V: 7.5% MAX	
	INSULATION RESISTANCE	
	500 MΩ MIN.	
	APPEARANCE:	CAPACITORS SHALL BE SUBJECTED TO A TEST OF
	NO ABNORMALITIES	(A) BELOW 1KV: 200% RATED VOLTAGE WITH 50mA
	CAP. CHANGE :	MAX.
	Y5P: ±15% MAX	(B) 1KV & ABOVE: 150% RATED VOLTAGE WITH 50mA
HIGH	Z5U & Y5U: ±20% MAX	MAX.
TEMPERATURE	Z5V: ±30% MAX	FOR 1000(+48/-0) HOURS AT $85 \pm 2^{\circ}$ C (FOR Y5U, Z5U,
LOADING	D.F.	Z5V) / AT 125 $\pm$ 3°C (ONLY FOR Y5P) AND THEN DRIED
LOADING	Y5P: 4% MAX	FOR 12∼24 HOURS AND MEASURED.
	Z5U & Y5U: 4% MAX	Pre-treatment:
	Z5V: 7.5% MAX	Capacitor shall be stored at125±3°C for 1hour.then placed at
	INSULATION RESISTANCE :	1room condition for 24±2hours
	$1000 \text{ M}\Omega$ MIN.	
	APPEARANCE:	CAPACITORS SHALL BE SUBJECTED TO:
	NO ABNORMALITIES	$-25\pm3^{\circ}\mathbb{C}(30\pm3\mathrm{min}) \rightarrow 25^{\circ}\mathbb{C}(3\mathrm{min}) \rightarrow 85\pm3^{\circ}\mathbb{C}(30\pm3\mathrm{min}) \rightarrow$
	CAP. CHANGE :	25°C (3min) FOR 5 CYCLE.
	Y5P: ±15% MAX	Pre-treatment:
	Z5U & Y5U: ±20% MAX	Capacitor shall be stored at125±3°C for 1hour.then placed at ₩
TEMPERATURE	Z5V: ±30% MAX	1room condition for 24±2hours
CYCLING	D.F.	
	Y5P: 5% MAX	
	Z5U & Y5U: 5% MAX	
	Z5V: 7.5% MAX	
	INSULATION RESISTANCE :	
	$1000 \ \mathrm{M}\Omega \ \mathrm{MIN}.$	



#### 8. Cautions & notices:

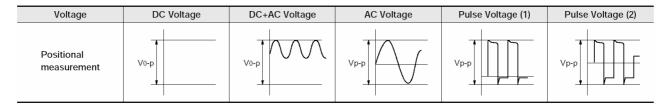
**\*Application:** DC or Low frequency(30~150Hz) High Voltage circuits. As coupling and decoupling capacitors for such application where higher losses and a reduced.

#### 8.1. Caution (Rating)

#### I. Operating Voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is applied to the circuit, starting or stopping may generate irregular voltage for a transit period because of resonance or switching. Be sure to use a capacitor with a rated voltage range that includes these irregular voltages.



#### II. Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high frequency current, pulse current or similar current, it may self-generate heat due to dielectric loss. The frequency of the applied sine wave voltage should be less than 150Hz. The applied voltage load (\*) should be such that the capacitor's self-generated heat is within 20°C at an atmosphere temperature of 25°C. When measuring, use a thermocouple of small thermal capacity-K of  $\emptyset$ 0.1mm in conditions where the capacitor is not affected by radiant heat from other components or surrounding ambient fluctuations.

Excessive heat may lead to deterioration of the capacitor's characteristics and reliability. (Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.)

#### III. Fail-Safe

When capacitor is broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

#### 8.2. Caution (Storage and operating condition)

#### I. Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed –10 to 40 degrees centigrade and 15 to 85 %.

Use capacitors within 6 months.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.

#### **8.3.**Caution (Soldering and Mounting)

#### I. Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

#### II. Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor.

Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element. When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage: 50W max.

Soldering time: 3.5 sec. max.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.

#### **8.4. Caution (Handling)**

Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PROUCT IS USED.

#### 8.5. Notice

#### 8.5.1. Notice (Soldering and Mounting)

Cleaning (ultrasonic cleaning)

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min. maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

#### 8.5.2. Notice (Rating)

Capacitance change of capacitor

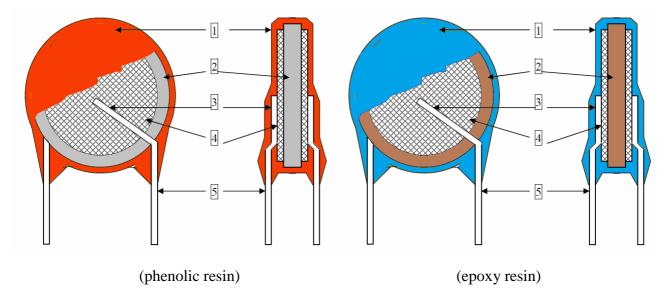
#### Class 2 series:

Capacitors have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor is left on for a long time. Moreover, capacitance might change greatly depending on the surrounding temperature or an applied voltage. So, it is not likely to be suitable for use in a time constant circuit.

Please contact us if you need detailed information.



### 9. Drawing of internal structure and material list:



	部位	材質	構成部份	供應商
NO.				
	Part name	Material	Component	Vendor
1	Insulation Coating	Phenolic resin	Phenolic resin, Filler, Pigment	Yantai Namics
		Epoxy resin	Epoxy resin, SiO2, TiO2	Kai Hua
2	Dielectric Element	Ceramic	BaTiO3	Hua Xing
				Fenghua
3	Solder	Tin-silver	Sn97.5-Ag2.5	Quan Jia
				Hili
4	Electrodes	Ag	Silver,Glass frit	Jiangyin-Xinguang
5	Leads wire	Tinned copper	Substrate metal:Fe&Cu	Samatron
		clad steel wire	Surface plating:Sn 100%	Wuhu Taili